

TRENCHSTOP[™] RC-Series for hard switching applications

IGBT with integrated diode in packages offering space saving advantage

Features:

TRENCHSTOPTM Reverse Conducting (RC) technology for 600V applications offering

- Optimised V_{CEsat} and V_{F} for low conduction losses
- · Smooth switching performance leading to low EMI levels
- Very tight parameter distribution
- Operating range of 1 to 20kHz
- Maximum junction temperature 175°C
- Short circuit capability of 5µs
- Best in class current versus package size performance
- · Qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant (for PG-TO252: solder

temperature 260°C, MSL1)

• Complete product spectrum and PSpice Models:

http://www.infineon.com/igbt/

Applications:

Consumer motor drives

Туре	VCE	<i>l</i> c	V _{CEsat} , T _{vj} =25°C	\mathcal{T}_{vjmax}	Marking	Package
IKD04N60R	600V	4A	1.65V	175°C	K04R60	PG-TO252-3
IKU04N60R	600V	4A	1.65V	175°C	K04R60	PG-TO251-3

Maximum ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CE}	600	V
DC collector current, limited by T_{vjmax} $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	<i>I</i> c	8.0 4.0	A
Pulsed collector current, t_p limited by T_{vjmax}	I Cpuls	12.0	A
Turn off safe operating area $V_{CE} \le 600V$, $T_{vj} \le 175^{\circ}C$	-	12.0	A
Diode forward current, limited by T_{vjmax} $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	ŀ	8.0 4.0	A
Diode pulsed current, t_p limited by T_{vjmax}	Fpuls	12.0	A
Gate-emitter voltage	V _{GE}	±20	V
Short circuit withstand time $V_{GE} = 15.0V, V_{CC} \le 400V, T_{vj} \le 150^{\circ}C$ Allowed number of short circuits < 1000 Time between short circuits: $\ge 1.0s$	<i>t</i> sc	5	μs
Power dissipation $T_{\rm C}$ = 25°C	Ptot	75.0	W
Operating junction temperature	T _{vj}	-40+175	°C
Storage temperature	<i>T</i> _{stg}	-55+175	°C
Soldering temperature, wavesoldering 1.6 mm (0.063 in.) from case for 10s	PG-TO251-3	260	°C
for 10 s (according to JEDEC J-STA-020A)	PG-TO252-3	260	







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Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance, junction - case	R _{th(j⁻c)}		2.00	K/W
Diode thermal resistance, junction - case	R _{th(j-c)}		4.50	K/W
Thermal resistance, min. footprint junction - ambient	R _{th(j-a)}	PG-TO252-3	75	K/W
Thermal resistance, 6cm² Cu on PCB junction - ambient	<i>R</i> th(j⁻a)	PG-TO252-3	50	K/W
Thermal resistance junction - ambient	R _{th(j-a)}	PG-TO251-3	75	K/W

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Desemptor	Symbol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Static Characteristic	•					
Collector-emitter breakdown voltage	V(BR)CES	V _{GE} = 0V, <i>I</i> _C = 0.20mA	600	-	-	V
Collector-emitter saturation voltage	V∕CEsat	V _{GE} = 15.0V, <i>I</i> _C = 4.0A <i>T</i> _{vj} = 25°C <i>T</i> _{vj} = 175°C		1.65 1.85	2.10	V
Diode forward voltage	Vŧ	V _{GE} = 0V, /= 4.0A 7 _{vj} = 25°C 7 _{vj} = 175°C		1.70 1.70	2.10	V
Gate-emitter threshold voltage	V _{GE(th)}	<i>I</i> _C = 0.07mA, <i>V</i> _{CE} = <i>V</i> _{GE}	4.3	5.0	5.7	V
Zero gate voltage collector current	<i>I</i> ces	$V_{CE} = 600V, V_{GE} = 0V$ $T_{vj} = 25^{\circ}C$ $T_{vj} = 175^{\circ}C$			40.0 1000.0	μA
Gate-emitter leakage current	<i>I</i> GES	<i>V</i> _{CE} = 0V, <i>V</i> _{GE} = 20V	-	-	100	nA
Transconductance	$g_{\sf fs}$	<i>V</i> _{CE} = 20V, <i>I</i> _C = 4.0A	-	2.2	-	S
Integrated gate resistor	<i>ľ</i> G			none		Ω

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Devenueder	Cumb al	Conditions	Value			Unit
Parameter	Symbol Conditions		min.	typ.	max.	Unit
Dynamic Characteristic						
Input capacitance	Cies		-	305	-	
Output capacitance	Coes	$V_{\rm CE} = 25 \text{V}, V_{\rm GE} = 0 \text{V}, \text{f} = 1 \text{MHz}$	-	18	-	pF
Reverse transfer capacitance	Cres		-	9	-]
Gate charge	<i>Q</i> G	V _{CC} = 480V, <i>I</i> _C = 4.0A, V _{GE} = 15V	-	27.0	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	LE	PG-TO252-3 PG-TO251-3	-	- 7.0	-	nH



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Switching Characteristic, Inductive Load, at $T_{vj} = 25^{\circ}C$

Parameter	Symbol			Value		
		Conditions	min.	typ.	max.	Unit
IGBT Characteristic			·			
Turn-on delay time	İ d(on)	<i>T</i> _{vj} = 25°C,	-	14	-	ns
Rise time	<i>t</i> r	$V_{CC} = 400V, I_C = 4.0A,$ $V_{GE} = 0.0/15.0V,$ $I_G = 43.0\Omega, L_{\sigma} = 60nH,$ $C_{\sigma} = 40pF$ L_{σ}, C_{σ} from Fig. E	-	8	-	ns
Turn-off delay time	<i>t</i> d(off)		-	146	-	ns
Fall time	<i>t</i> f		-	171	-	ns
Turn-on energy	Eon		-	0.09	-	mJ
Turn-off energy	E _{off}		-	0.15	-	mJ
Total switching energy	Ets		-	0.24	-	mJ

Anti-Parallel Diode Characteristic, at $T_{vj} = 25^{\circ}C$

Diode reverse recovery time	<i>t</i> rr	$T_{\rm vj} = 25^{\circ} \rm C,$	-	43	-	ns
Diode reverse recovery charge	Qrr	l∕R = 400V, l≠ = 4.0A,	-	0.22	-	μC
Diode peak reverse recovery current	<i>I</i> rrm	<i>di</i> ⊧ <i>/dt</i> = 600A/µs	-	7.6	-	A
Diode peak rate of fall of reverse recovery current during t _b	di _{rr} /dt		-	-330	-	A/µs

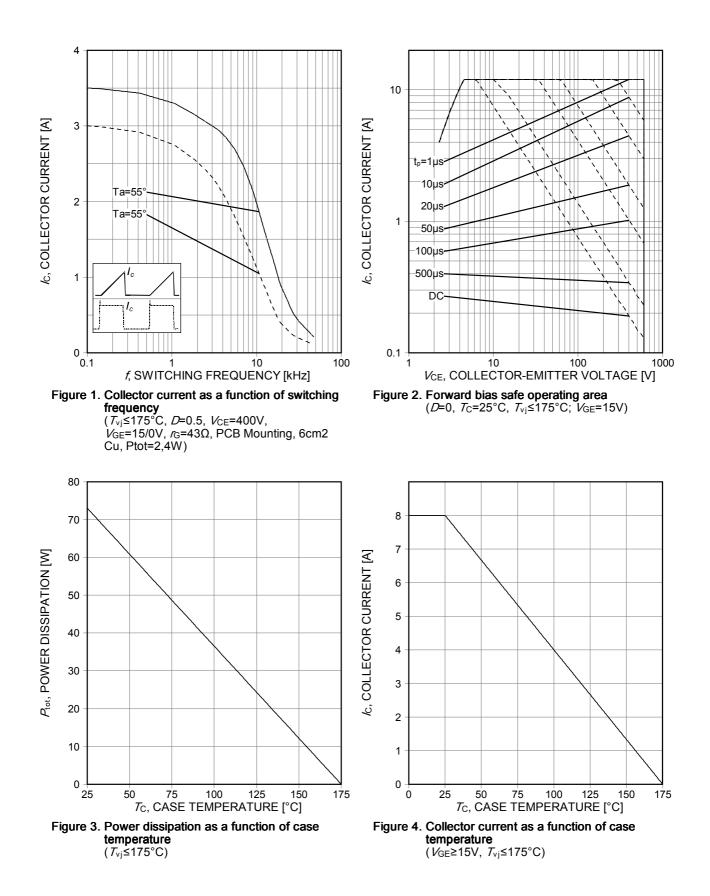
Switching Characteristic, Inductive Load, at T_{vj} = 175°C

Parameter	Symbol Conditions	O a maliti a ma		Value		
		Conditions	min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t d(on)	<i>T</i> _{vj} = 175°C,	-	12	-	ns
Rise time	t _r	$V_{CC} = 400V, I_C = 4.0A,$ $V_{GE} = 0.0/15.0V,$	-	8	-	ns
Turn-off delay time	<i>t</i> d(off)	$r_{\rm G}$ = 43.0 Ω , L_{σ} = 60nH,	-	177	-	ns
Fall time	<i>t</i> f	$C_{\sigma} = 40 \text{pF}$ L_{σ}, C_{σ} from Fig. E	-	165	-	ns
Turn-on energy	Eon	20, 00 nom ng. 2	-	0.16	-	mJ
Turn-off energy	Eoff		-	0.24	-	mJ
Total switching energy	Ets		-	0.40	-	mJ

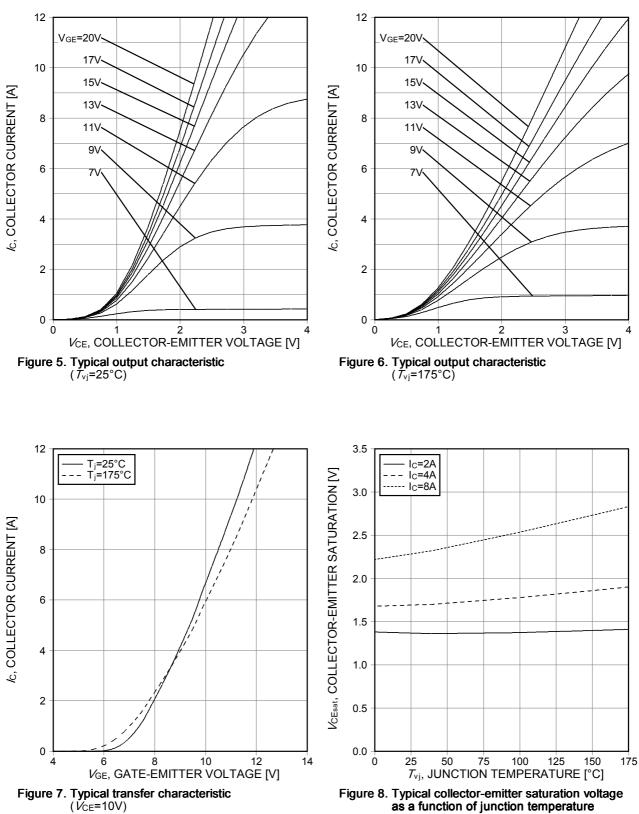
Anti-Parallel Diode Characteristic, at T_{vj} = 175°C

Diode reverse recovery time	<i>t</i> rr	$T_{\rm vj} = 175^{\circ}{\rm C},$	-	98	-	ns
Diode reverse recovery charge	Qrr	V _R = 400V, /= = 4.0A.	-	0.52	-	μC
Diode peak reverse recovery current	<i>I</i> _{rrm}	<i>di</i> ⊧ <i>/dt</i> = 600A/µs	-	11.0	-	Α
Diode peak rate of fall of reverse recovery current during to	di _{rr} /dt		-	-200	-	A/µs

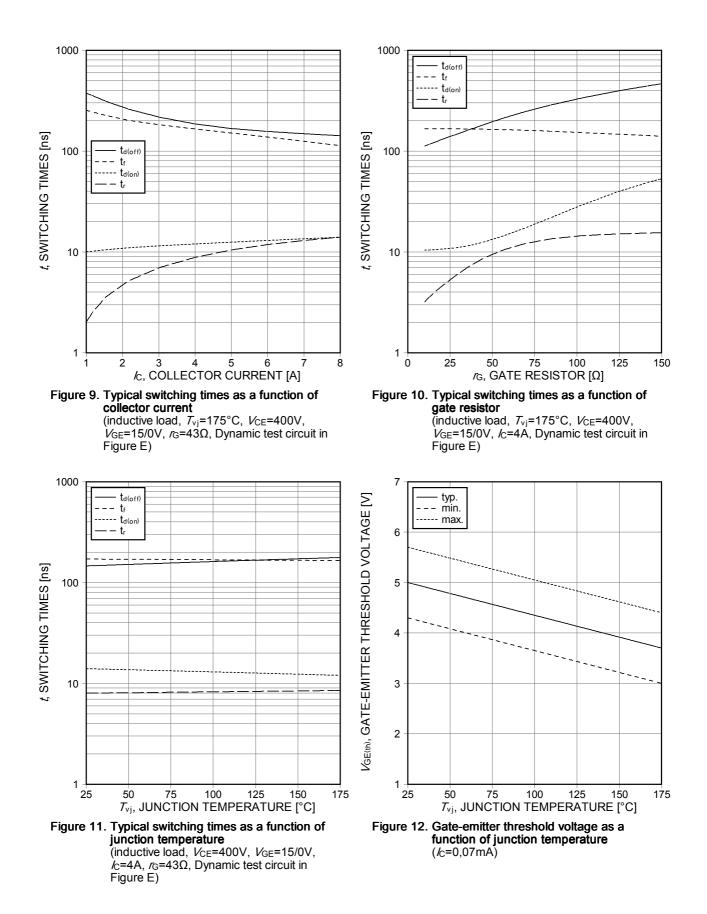




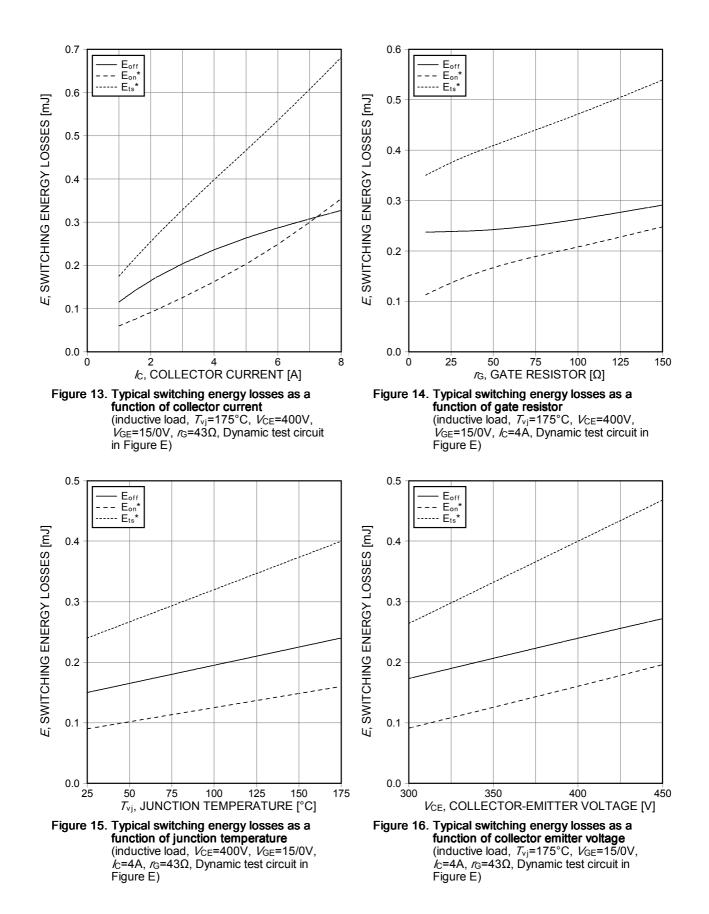




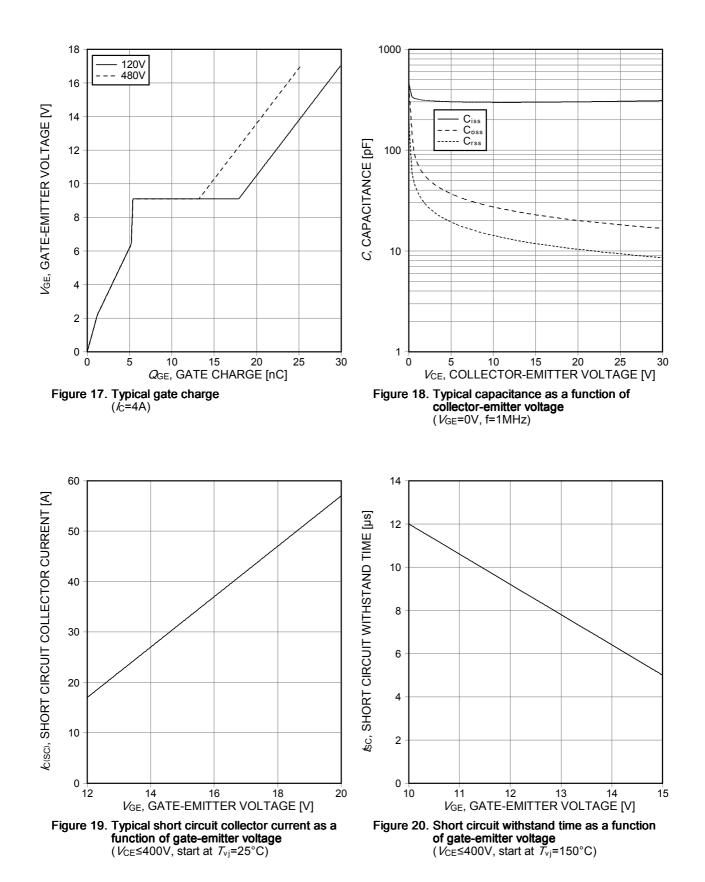




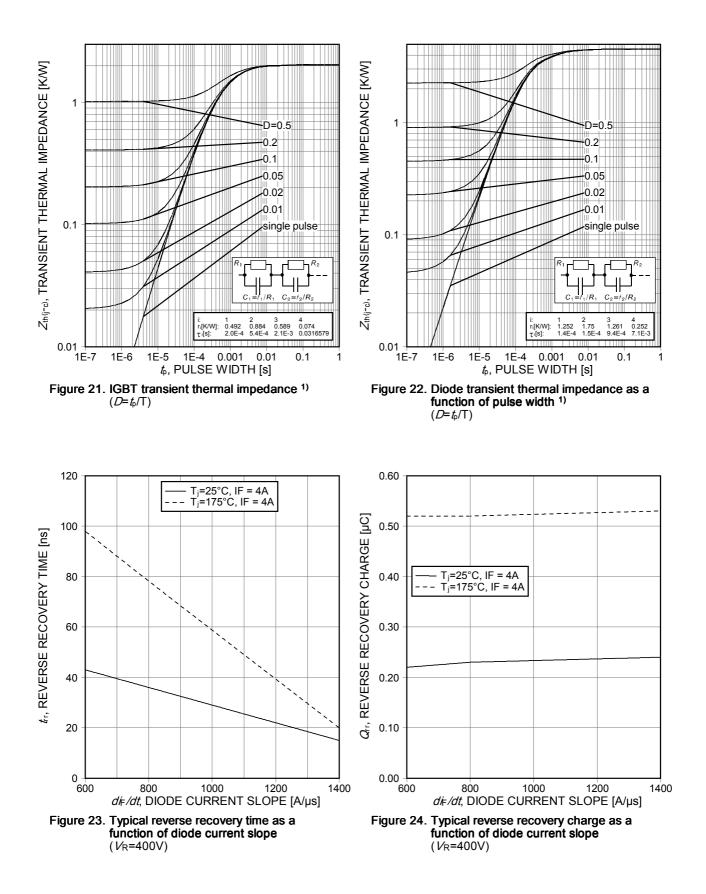




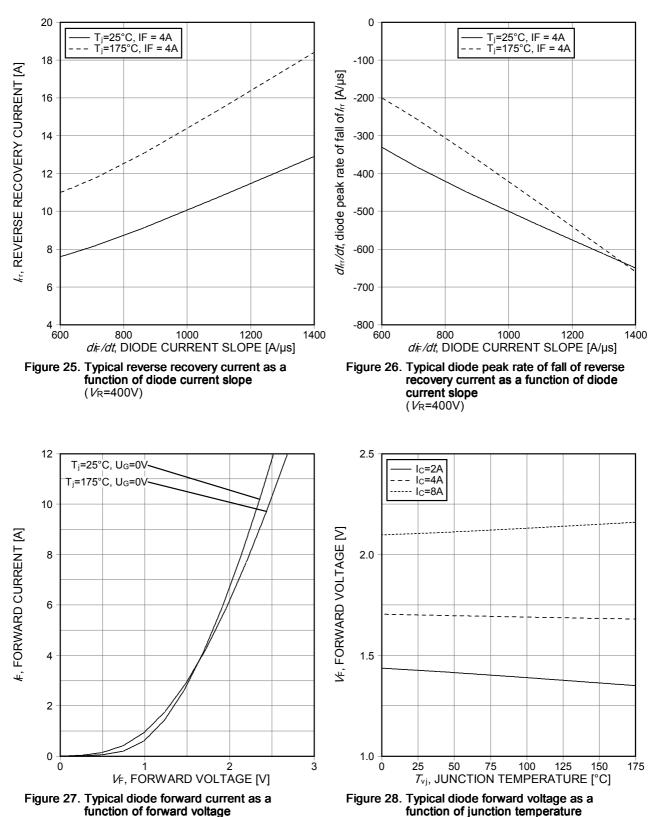






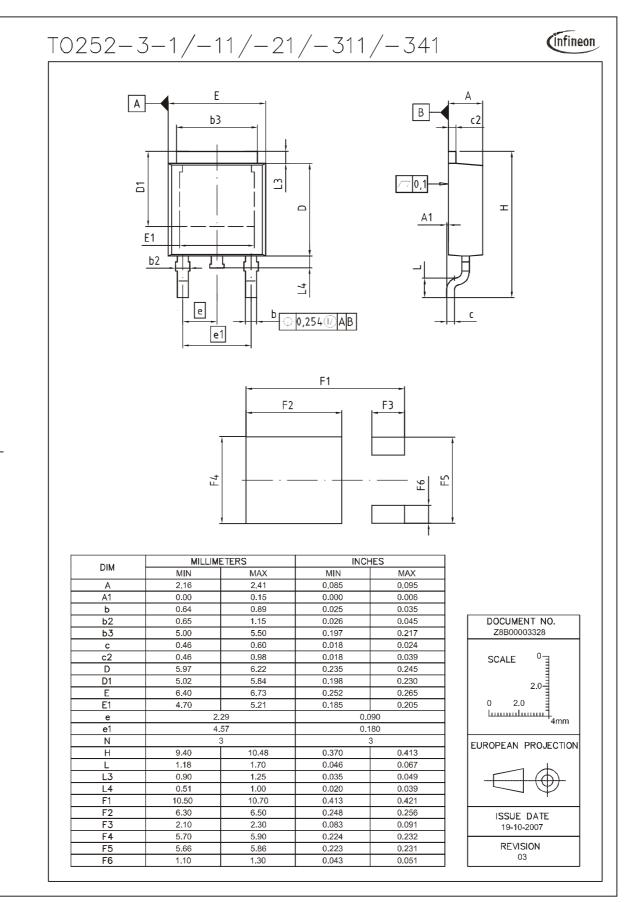




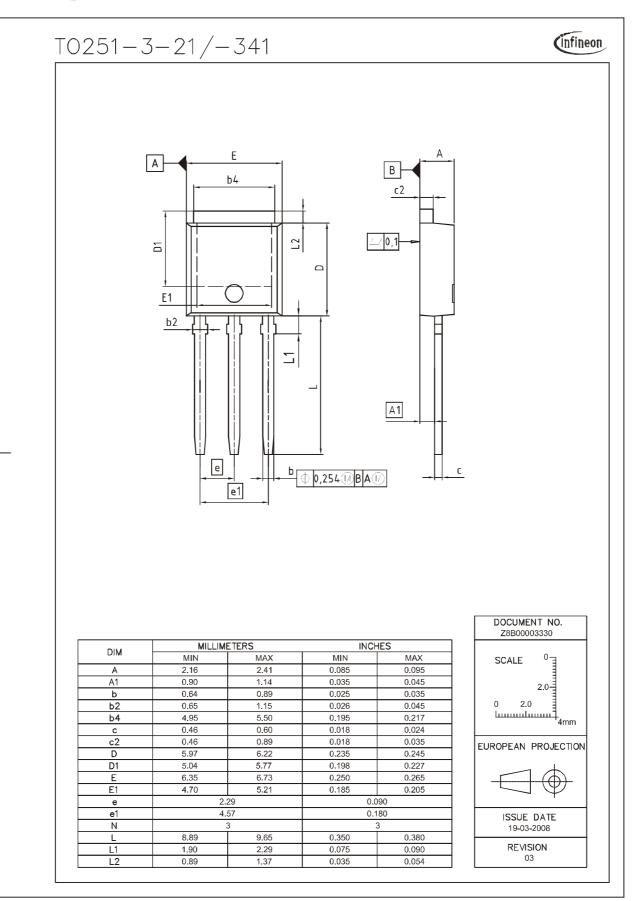


function of forward voltage

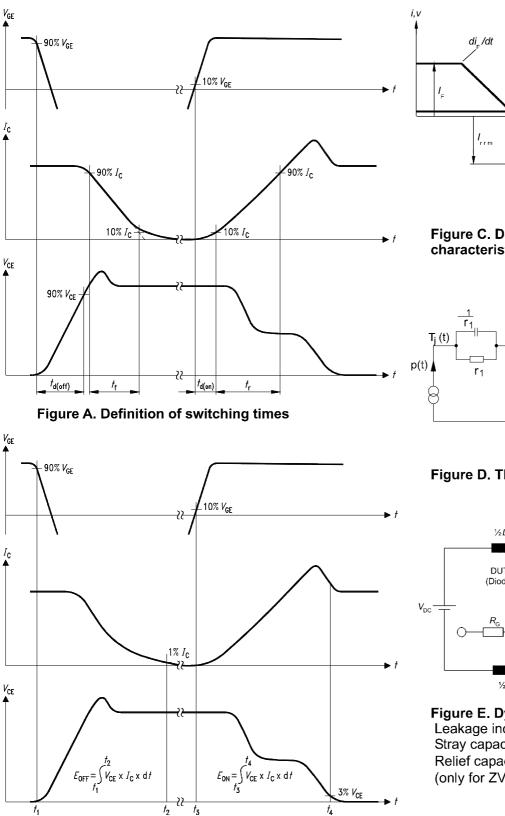














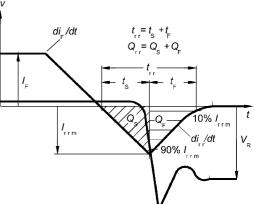


Figure C. Definition of diodes switching characteristics

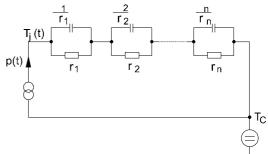


Figure D. Thermal equivalent circuit

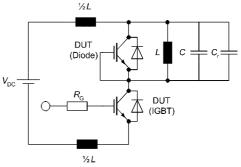


Figure E. Dynamic test circuit Leakage inductance L= 180nH, Stray capacitor C_{σ} = 40pF, Relief capacitor C_{r} = 1nF (only for ZVT switching)



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¹⁾ Rth/Zth based on single cooling pulse. Please be aware that a correct Rth measurement of this device, is not possible using a thermocouple.